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Specification for additive manufacturing file format (AMF) Version 1.2

*Spécification pour le format de fichier pour la fabrication additive
(AMF) Version 1.2*



Reference number
ISO/ASTM 52915:2020(E)

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Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

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This document was prepared by Technical Committee ISO/TC 261, *Additive manufacturing*, in cooperation with ASTM F 42.91, *Terminology*, on the basis of a partnership agreement between ISO and ASTM International with the aim to create a common set of ISO/ASTM standards on Additive Manufacturing.

This second edition cancels and replaces the first edition (ISO/ASTM 52915:2016), which has been technically revised.

The main changes compared to the previous edition are as follows:

- Harmonization of the terminology definition shared with ISO/ASTM 52900 in [3.8](#);
- Corrections to [Figures 1](#) to [6](#) in [7.1](#), [8.1.2](#), [9.1.1](#), [11.4](#) and [12](#);
- Corrections of typographic issues in [Table A.1](#) and Table A.4.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at www.iso.org/members.html.

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Introduction

This document describes an interchange format to address the current and future needs of additive manufacturing technology. For the last three decades, the stereolithography (STL) file format has been the industry standard for transferring information between design programs and additive manufacturing equipment. An STL file defines only a surface mesh and has no provisions for representing colour, texture, material, substructure and other properties of the fabricated object. As additive manufacturing technology is evolving quickly from producing primarily single-material, homogeneous objects to producing geometries in full colour with functionally defined gradations of materials and microstructures, there is a growing need for a standard interchange file format that can support these features.

The Additive Manufacturing File Format (AMF) has many benefits. It describes an object in such a general way that any machine can build it to the best of its ability, and as such is technology independent. It is easy to implement and understand, scalable and has good performance. Crucially, it is both backwards compatible, allowing any existing STL file to be converted, and future compatible, allowing new features to be added as advances in technology warrant.